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(12) United States Patent

Sherrer et al.

(54) COAXIAL WAVEGUIDE MICROSTRUCTURES HAVING AN ACTIVE DEVICE AND METHODS OF FORMATION THEREOF

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(57) **ABSTRACT**

Provided are coaxial waveguide microstructures. The microstructures include a substrate and a coaxial waveguide disposed above the substrate. The coaxial waveguide includes: a center conductor; an outer conductor including one or more walls, spaced apart from and disposed around the center conductor; one or more dielectric support members for supporting the center conductor in contact with the center conductor and enclosed within the outer conductor; and a core volume between the center conductor and the outer conductor, wherein the core volume is under vacuum or in a gas state. Also provided are methods of forming coaxial waveguide microstructures by a sequential build process and hermetic packages which include a coaxial waveguide microstructure.

20 Claims, 18 Drawing Sheets

